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## Product Change Notification - JAON-15PAQT740 [\(Printer Friendly\)](#)

**Date:** 31 Oct 2014

**Notification subject:** CCB 1155.38 Initial Notice: Qualification of palladium coated copper (PdCu) bond wire in selected products of the 120K, 121K, 150K, 160K and 200K wafer technologies in 14L SOIC package at MTAI site.

**Notification text:** **PCN Status:**  
Initial notification

**Microchip Parts Affected:**

See attachments of affected catalog part numbers (CPN) labeled as...

[PCN\\_JAON-15PAQT740\\_Affected\\_CPN.xls](#)

[PCN\\_JAON-15PAQT740\\_Affected\\_CPN.pdf](#)

**Description of Change:**

Qualification of palladium coated copper (PdCu) bond wire in selected products of the 120K, 121K, 150K, 160K and 200K wafer technologies available in 14L SOIC package at MTAI assembly site.

NOTE: Selected products are non-automotive devices. Please review the affected CPN lists (attached) to identify the actual parts affected.

**Impacts to Data Sheet:**

None

**Reason for Change:**

To improve manufacturability and qualify PdCu bond wire at MTAI assembly site.

**Change Implementation Status:**

In Progress

**Estimated First Ship Date:**

December 19, 2014 (date code: 1451)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Markings to Distinguish Revised from Unrevised Devices:**

Traceability code

**Revision History:**

**October 31, 2014:** Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):** [PCN\\_JAON-15PAQT740\\_Qual Plan.pdf](#)  
[PCN\\_JAON-15PAQT740\\_Affected CPN.pdf](#)  
[PCN\\_JAON-15PAQT740\\_Affected CPN.xls](#)

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